

# Product / Process Change Notification



N° 2020-026-A

Dear Customer,

Please find attached our INFINEON Technologies PCN:

## Capacity extension with introduction of additional wafer production at Systems on Silicon Manufacturing Company for the Driver IC and assembly/final test location at ASE Electronics (M) Sdn. Bhd. for Voyager/Traveler family devices

Important information for your attention:

- Please respond to this PCN by indicating your decision on the approval form, sign it and return to your sales partner before **3<sup>rd</sup> June 2020**.
- Infineon aligns with the widely-recognized JEDEC STANDARD “**JESD46**“, which stipulates: **“Lack of acknowledgement of the PCN within 30 days constitutes acceptance of the change.”**

Your prompt reply will help Infineon Technologies to assure a smooth and well executed transition. If Infineon does not hear from your side by the due date, we will assume your full acceptance to this proposed change and its implementation.

Your attention and response to this matter is greatly appreciated.

Infineon Technologies AG  
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Chairman of the Supervisory Board: Dr. Wolfgang Eder  
Management Board: Dr. Reinhard Ploss (CEO), Dr. Helmut Gassel, Jochen Hanebeck, Dr. Sven Schneider  
Registered Office: Neubiberg  
Commercial Register: München HRB 126492

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► **Products affected:**

Please refer to attached affected product list 1\_cip20026\_a



► **Detailed Change Information:**

- Subject:**
- Capacity extension with introduction of additional Wafer Production at Systems on Silicon Manufacturing Company for the Driver IC and Assembly/Final Test location at ASE Electronics (M) Sdn. Bhd. for Voyager/Traveler family devices
  - New wafer production at SSMC (Singapore) is running under the same process and parent company (TSMC, Taiwan) where the existing chip production is located.
  - Extension of TDA21472 into Infineon Technologies (M) Sdn Bhd for assembly and Infineon Technologies (Singapore) for final test

**Reason:** Expansion of wafer production, assembly and test production to assure continuity of supply and enable flexible manufacturing.

**Description:**

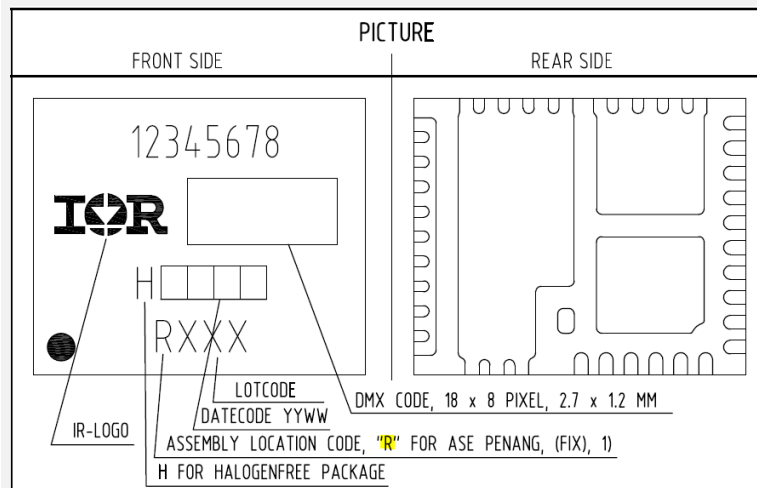
Old

New

- Please refer to 3\_cip20026

► **Product Identification:**

External traceability assured via assembly location code "R" for ASE Electronics (M) Sdn. Bhd.



No change in SP ordering number

► **Impact of Change:**

No impact on electrical performance. Quality and reliability verified by qualification. There is no change in form, fit and function.

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## ► Attachments:

Affected product list 1\_cip20026\_a  
Qualification Report 2\_cip20026\_a  
Additional Information 3\_cip20026\_a

## ► Time Schedule:

- Final qualification report: available
- First samples available: May 2020 or earlier
- Intended start of delivery: August 2020 or earlier depending on PCN acceptance

If you have any questions, please do not hesitate to contact your local Sales office.